



Click [here](#) for the 3D model.

Dimensions	
Chip Size	1812
L	4.5mm +0.5/-0.3mm
W	3.2mm +/-0.4mm
T	1.25mm +/-0.1mm
S	3.5mm MIN
B	0.5mm +/-0.25mm

Packaging Specifications	
Packaging	T&R
Packaging Quantity	1000

General Information	
Series	CAS SMD SFTY 250
Style	SMD Chip
Description	Industrial Grade, Safety MLCC
RoHS	Yes
Termination	Tin
Safety Class	X2
Qualifications	ENEC, UL, IEC
AEC-Q200	No
Halogen Free	Yes

Specifications	
Capacitance	330 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	20%
Voltage AC	250 VAC (X2)
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Insulation Resistance	100 GOhms
Quality Factor	1000